

# Search Notes

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2347	(438/622).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/17 17:42
L2	2223	(438/637).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/17 17:45
S1	855	electroless\$2 with plat\$3 and grind\$3 and laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 01:53
S2	487	electroless\$2 with plat\$3 and grind\$3 and laser and electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 01:54
S3	416	electroless\$2 with plat\$3 and grind\$3 and laser and electrode and (resin or laminate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 01:54
S4	153	electroless\$2 with plat\$3 and grind\$3 and laser and electrode and (resin or laminate) and bond\$3 and dic\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 01:55
S5	227	electroless\$2 with plat\$3 and (grind\$3 or polish\$3) and laser and electrode and (resin or laminate) and bond\$3 and dic\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 01:57
S6	199	electroless\$2 with plat\$3 and (grind\$3 or polish\$3) and laser and electrode and (resin ) and bond\$3 and dic\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 01:57
S7	200	electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin ) and bond\$3 and dic\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 01:59

S8	92	electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin ) and bond\$3 and dic\$3 and electroplat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 15:49
S9	746	(438/460).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/15 02:05
S10	758	(438/459).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/15 02:06
S11	620	(438/675).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/15 02:06
S12	752	(438/678).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/15 02:06
S13	289	(438/674).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/15 02:06
S14	7	electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin with laminate ) and bond\$3 and dic\$3 and electroplat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 18:54
S15	9	SORIMACHI-HARUO.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 18:26
S16	23	electroless\$2 with plat\$3 and (grind\$3 or polish\$3 or abrad\$3) and laser and electrode and (resin with laminate ) and electroplat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/04/15 18:55